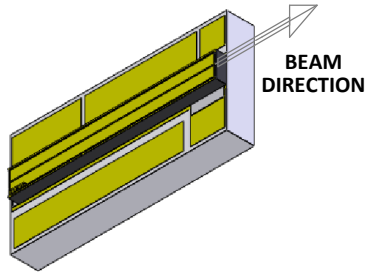
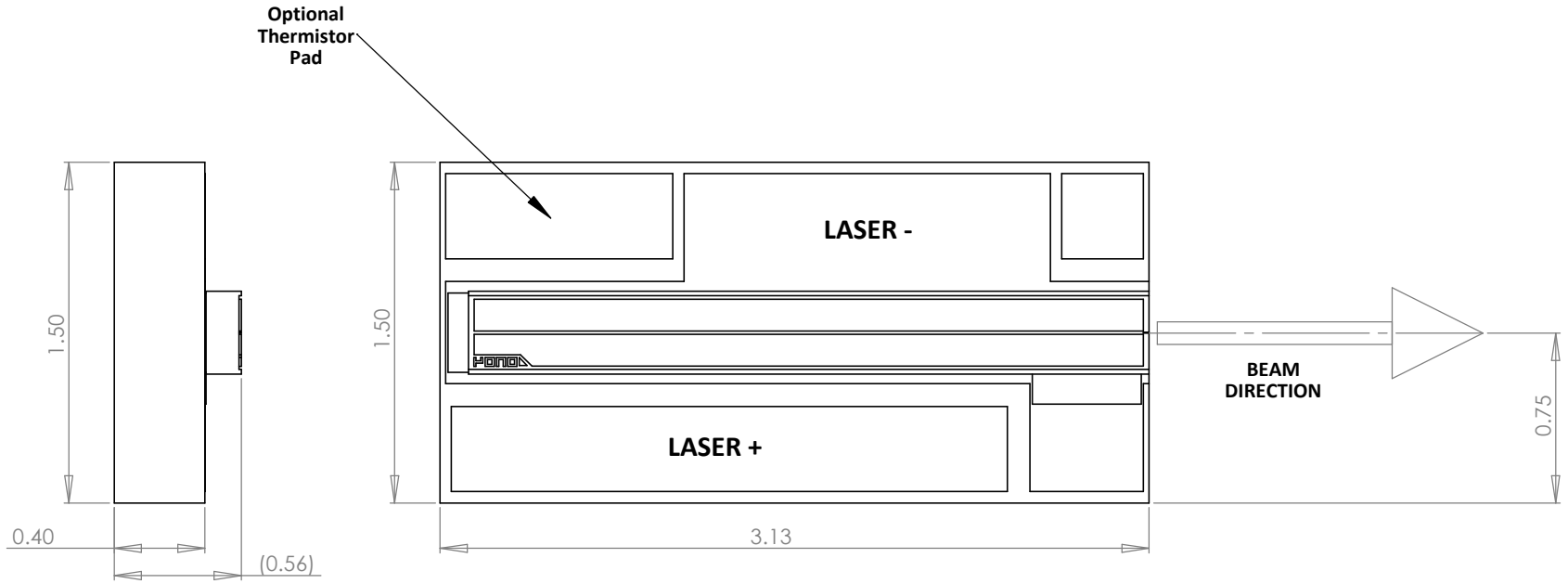


REVISION			
REV.	DESCRIPTION	DATE	APPROVED
01	INITIAL RELEASE	07/26/2016	BP
A	ECO#	07/27/2016	BP



- NOTE:**
1. Reference Chip Size, 3.0mm X 0.5 mm
 2. Maximum processing temperature 250°C

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DIMENSIONS mm [in]	NAME	DATE
UNLESS OTHERWISE SPECIFIED TOLERANCES ARE:	DRAWN	BP 07/27/2016
ANGULAR: ± 30 MINUTES	CHECKED	
X ± .25 [.010]	ENG APPR.	~
X.X ± .13 [.005]	MFG APPR.	~
X.XX ± .05 [.002]	Q.A.	~
X.XXX ± .025 [.001]		
INTERPRET GEOMETRIC TOLERANCING PER: ASME Y14.5M-1994		
MATERIAL	THIRD ANGLE PROJECTION	
NA		
FINISH (UNLESS OTHERWISE SPECIFIED)		
DO NOT SCALE DRAWING		

		TITLE:	
		C3-MOUNT, TYP	
SIZE	DWG. NO.	REV	
B	RDW 840038		
SCALE: 50:1			SHEET 1 OF 1